

## TRANSMITTAL

Electronic Version v1.1

Stylesheet Version v1.1.0

<b>Title of Invention</b>	<b>CHIP STRUCTURE WITH BUMPS AND A PROCESS FOR FABRICATING THE SAME</b>	
Application Number :		
Date :		
First Named Applicant:	Mr. Chao-Fu Weng	
Confirmation Number:		
Attorney Docket Number:	8012-US-PA-1	
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Submitted By:		Elec. Sign.
Dr. Belinda Lee Registered Number: 46,863		/Belinda Lee/ Sign. Capacity Agent

Documents being submitted:	Files
us-request	8012-D-usrequ.xml us-request.dtd us-request.xsl
us-fee-sheet	8012-D-usfees.xml us-fee-sheet.xsl us-fee-sheet.dtd
application-body	8012Dusf.xml application-body.dtd Image1.tif Image2.tif Image3.tif Image4.tif Image5.tif isoamsa.ent isoamsb.ent isoamsc.ent isoamsn.ent isoamso.ent isoamsr.ent isobox.ent isocyr1.ent isocyr2.ent isodia.ent isogr1.ent isogr2.ent isogr3.ent isogr4.ent isolat1.ent isolat2.ent isomfrk.ent isomopf.ent isomscr.ent isonum.ent isopub.ent isotech.ent mathml2.dtd mathml2-qname-1.mod mmlalias.ent mmlextra.ent soextblx.dtd us-application-body.xsl wipo.ent
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**Comments**

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